

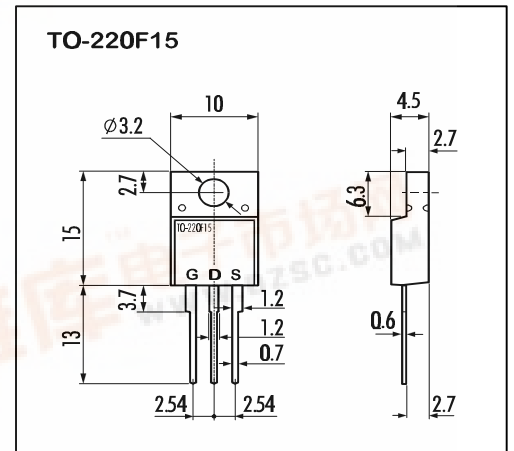
> Features

- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- Avalanche Rated

> Applications

- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

> Outline Drawing

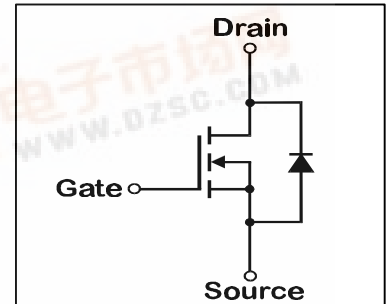


> Maximum Ratings and Characteristics

- Absolute Maximum Ratings (T<sub>C</sub>=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	60	V
Continuous Drain Current	I <sub>D</sub>	±45	A
Pulsed Drain Current	I <sub>D(puls)</sub>	±185	A
Gate-Source-Voltage	V <sub>GS</sub>	±20	V
Maximum Avalanche Energy	E <sub>AV</sub>	461.9	mJ*
Max. Power Dissipation	P <sub>D</sub>	40	W
Operating and Storage Temperature Range	T <sub>ch</sub>	150	°C
	T <sub>stg</sub>	-55 ~ +150	°C

L=0.304mH, V<sub>CC</sub>=24V



- Electrical Characteristics (T<sub>C</sub>=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =1mA V <sub>GS</sub> =0V	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =1mA V <sub>DS</sub> =V <sub>GS</sub>	1,0	1,5	2,0	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V T <sub>ch</sub> =25°C		10	500	μA
		V <sub>GS</sub> =0V T <sub>ch</sub> =125°C		0,2	1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V V <sub>DS</sub> =0V		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =22,5A V <sub>GS</sub> =4V		15	20	mΩ
		I <sub>D</sub> =22,5A V <sub>GS</sub> =10V		10	12	mΩ
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =22,5A V <sub>DS</sub> =25V	15	35		S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V		2900	4350	pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V		930	1400	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f=1MHz		260	390	pF
Turn-On-Time t <sub>on</sub> (t <sub>on</sub> =t <sub>d(on)</sub> +t <sub>r</sub> )	t <sub>d(on)</sub>	V <sub>CC</sub> =30V		13	30	ns
		V <sub>GS</sub> =10V		35	50	ns
Turn-Off-Time t <sub>off</sub> (t <sub>off</sub> =t <sub>d(off)</sub> +t <sub>f</sub> )	t <sub>d(off)</sub>	I <sub>D</sub> =45A		190	290	ns
		R <sub>GS</sub> =10 Ω		75	140	ns
Avalanche Capability	I <sub>AV</sub>	L = 100μH T <sub>ch</sub> =25°C	45			A
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =45A V <sub>GS</sub> =0V T <sub>ch</sub> =25°C		0,95	1,43	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =45A V <sub>GS</sub> =0V		55		ns
Reverse Recovery Charge	Q <sub>rr</sub>	-di/dt=100A/μs T <sub>ch</sub> =25°C		0,10		μC

- Thermal Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance	R <sub>th(ch-c)</sub>			3,125	°C/W
	R <sub>th(ch-a)</sub>			62,5	°C/W

N-channel MOS-FET			
60V	0,02Ω	±45A	40W

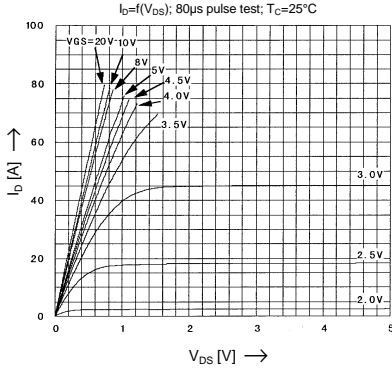
# 2SK2897-01MR

## FAP-III B Series

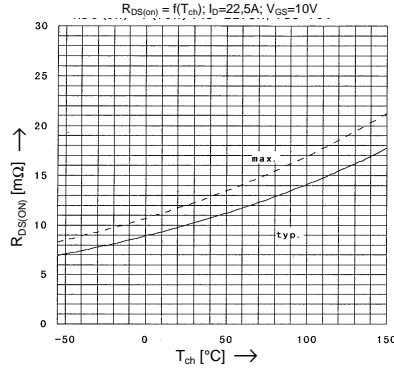


### > Characteristics

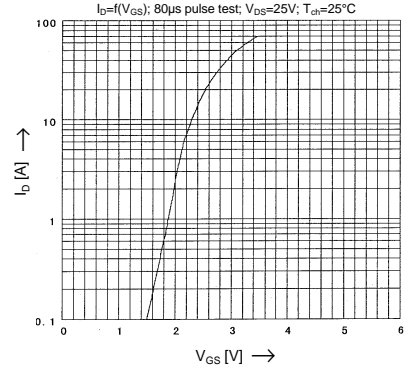
Typical Output Characteristics



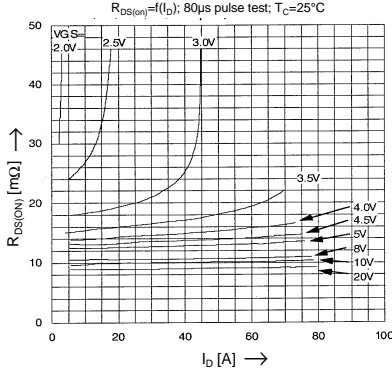
Drain-Source On-State Resistance vs.  $T_{ch}$



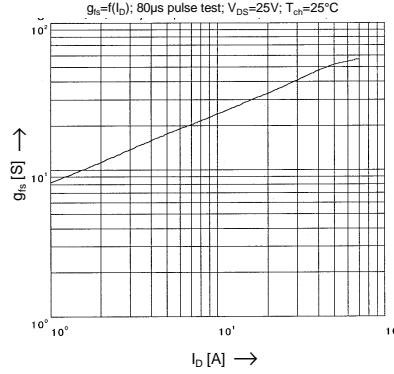
Typical Transfer Characteristics



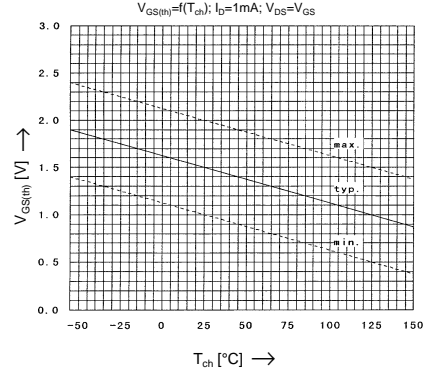
Typical Drain-Source On-State-Resistance vs.  $I_b$



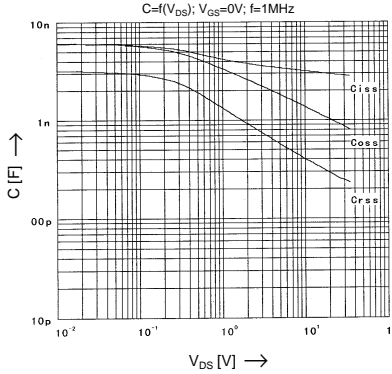
Typical Forward Transconductance vs.  $I_b$



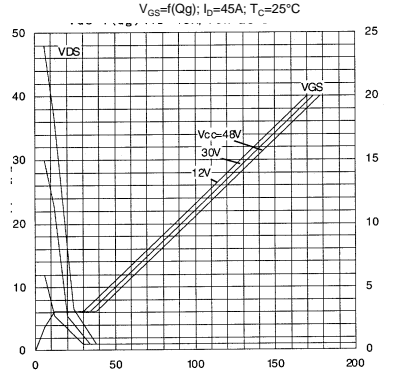
Gate Threshold Voltage vs.  $T_{ch}$



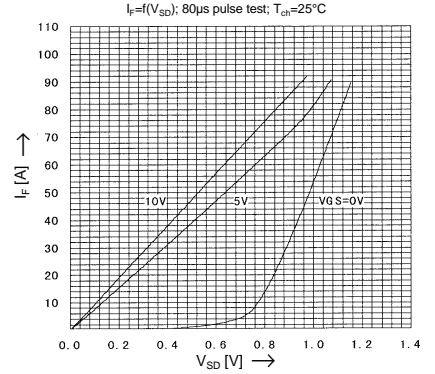
Typical Capacitances vs.  $V_{DS}$



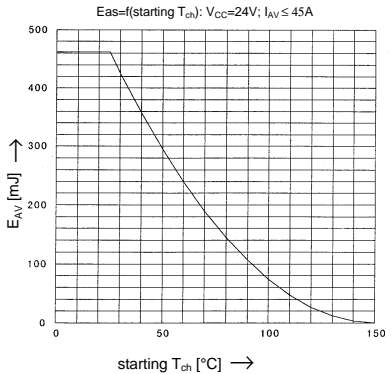
Typical Gate Charge Characteristic



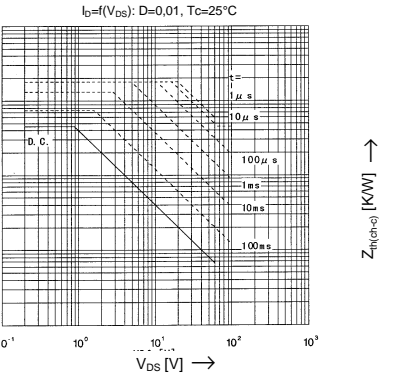
Forward Characteristics of Reverse Diode



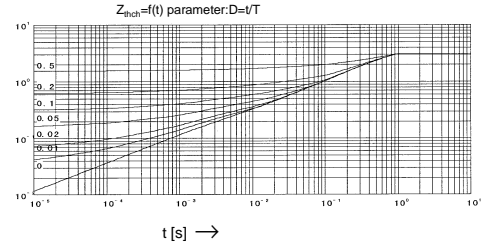
Maximum Avalanche Energy vs. starting  $T_{ch}$



Safe Operation Area



Transient Thermal impedance



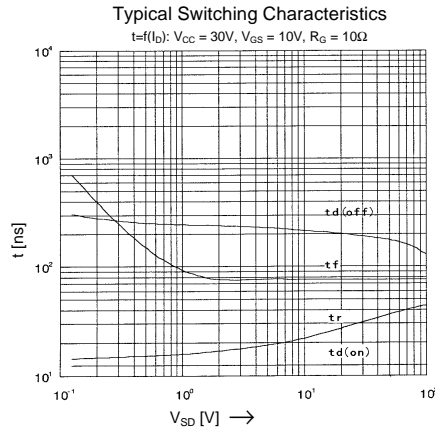
N-channel MOS-FET			
60V	0,02Ω	±45A	40W

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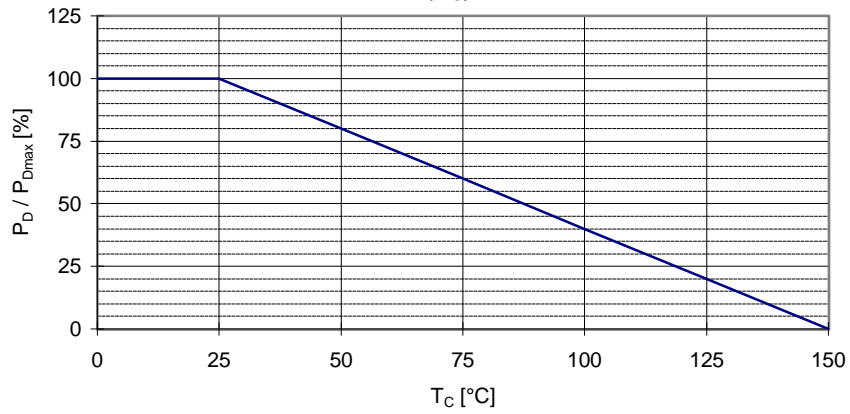
## FAP-IIIB Series



### > Characteristics



### Power Dissipation $P_D=f(T_C)$



### Maximum Avalanche Current vs. starting $T_{ch}$ $I_{AV}=f(\text{starting } T_{ch})$

